DATA SHEET



BIPOLAR ANALOG INTEGRATED CIRCUIT μPC79Lxx Series

THREE TERMINAL NEGATIVE VOLTAGE REGULATOR

<R> **DESCRIPTION**

The μ PC79Lxx Series are three-terminal negative output voltage stabilization power supply circuit of fixed output voltage. It regulates non-stabilized DC input voltage to output stabilized fixed voltage.

The four types of voltage value are -5 V, -8 V, -12 V, and -15 V, and they can be respectively used as power supply circuit with maximum current capacity 100 mA.

<R> **FEATURES**

• Output current: 100 mA

 On-chip some protection circuits (over current protection, thermal shut down)

• Low noise : 31 μ V r.m.s. (μ PC79L05) • High ripple rejection : 85 dB (μPC79L05)

• TO-92 package

ORDERING INFORMATION

Part Number	Package	Output Voltage	Marking	Package Type
μ PC79L05J	3-PIN PLASTIC SIP (TO-92)	–5 V	79L05	Packed in envelope
μ PC79L05J-A Note	3-PIN PLASTIC SIP (TO-92)	–5 V	79L05	Packed in envelope
μ PC79L05J-T	3-PIN PLASTIC SIP (TO-92)	−5 V	79L05	Cube type taping 2500 pcs/cube
μ PC79L05J-T-A Note	3-PIN PLASTIC SIP (TO-92)	–5 V	79L05	Cube type taping 2500 pcs/cube
μ PC79L08J	3-PIN PLASTIC SIP (TO-92)	–8 V	79L08	Packed in envelope
μ PC79L08J-A Note	3-PIN PLASTIC SIP (TO-92)	–8 V	79L08	Packed in envelope
μ PC79L08J-T	3-PIN PLASTIC SIP (TO-92)	–8 V	79L08	Cube type taping 2500 pcs/cube
μ PC79L08J-T-A Note	3-PIN PLASTIC SIP (TO-92)	–8 V	79L08	Cube type taping 2500 pcs/cube
μ PC79L12J	3-PIN PLASTIC SIP (TO-92)	–12 V	79L12	Packed in envelope
μ PC79L12J-A Note	3-PIN PLASTIC SIP (TO-92)	–12 V	79L12	Packed in envelope
μ PC79L12J-T	3-PIN PLASTIC SIP (TO-92)	–12 V	79L12	Cube type taping 2500 pcs/cube
μ PC79L12J-T-A Note	3-PIN PLASTIC SIP (TO-92)	–12 V	79L12	Cube type taping 2500 pcs/cube
μ PC79L15J	3-PIN PLASTIC SIP (TO-92)	–15 V	79L15	Packed in envelope
μPC79L15J-A Note	3-PIN PLASTIC SIP (TO-92)	–15 V	79L15	Packed in envelope
μ PC79L15J-T	3-PIN PLASTIC SIP (TO-92)	–15 V	79L15	Cube type taping 2500 pcs/cube
μ PC79L15J-T-A Note	3-PIN PLASTIC SIP (TO-92)	–15 V	79L15	Cube type taping 2500 pcs/cube

Note Pb-free (This product does not contain Pb in external electrode and other parts).

Output voltage -5 V product is written in the text as μ PC79L05.

It applies to other output voltage products as same.

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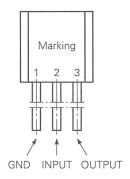
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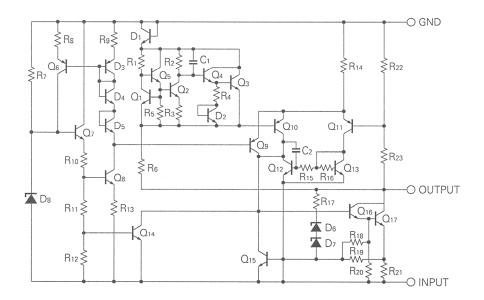
Printed in Japan

PIN CONFIGURATION (Marking Side)

3-PIN PLASTIC SIP (TO-92)



EQUIVALENT CIRCUIT



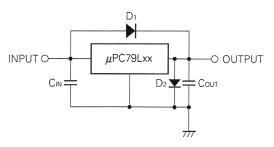
ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter	Symbol	Rating	Unit
Input Voltage	Vin	-30/-35 Note	V
Internal Power Dissipation	Рт	700	mW
Operating Ambient Temperature	Та	−20 to +85	°C
Operating Junction Temperature	TJ	-20 to +150	°C
Storage Temperature	Tstg	-55 to +150	°C
Thermal Resistance (junction to ambient)	Rth(J-A)	180	°C/W

Note μ PC79L05, 08 : -30 V, μ PC79L12, 15 : -35 V

<R> Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

<R> TYPICAL CONNECTION



 C_{IN} : Required if regulator is located an appreciable distance from power supply filter (More than 2.2 μ F).

Cout: Connect it within 2 cm from OUTPUT pin and GND pin (More than 1 μ F).

 D_1 : Needed for $V_{IN} > V_O$. D_2 : Needed for $V_O > GND$.

RECOMMENDED OPERATING CONDITIONS

RECOMMENDED OF EXAMING CONDITIONS						
Parameter	Symbol	Type Number	MIN.	TYP.	MAX.	Unit
Input Voltage	Vin	μPC79L05	-7	-10	-20	V
		μPC79L08	-10.5	-14	-23	٧
		μPC79L12	-14.5	-19	-27	٧
		μPC79L15	-17.5	-23	-30	٧
Output Current	lo	All	0	40	70	mA
Operating Ambient Temperature	TA	All	-20		+85	°C
Operating Junction Temperature	TJ	All	-20	75	+125	°C

ELECTRICAL CHARACTERISTICS

 μ PC79L05 (V_{IN} = -10 V, Io = 40 mA, 0°C \leq T_J \leq +125°C, C_{IN} = 2.2 μ F, C_{OUT} = 1 μ F, unless otherwise specified)

		·				
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output Voltage	Vo	T _J = 25°C	-4.8	-5.0	-5.2	V
		$-7 \text{ V} \le V_{IN} \le -20 \text{ V}, \ 1 \text{ mA} \le I_0 \le 40 \text{ mA}$	-4.75		-5.25	V
Line Regulation	REGIN	T _J = 25°C, −7 V ≤ V _{IN} ≤ −20 V		3	60	mV
Load Regulation	REG∟	T _J = 25°C, 1 mA ≤ I _O ≤ 100 mA		10	50	mV
Quiescent Current	IBIAS	T _J = 25°C		4.2	6.0	mA
Quiescent Current Change	⊿IBIAS	-7 V ≤ V _{IN} ≤ -20 V, Io = 40 mA			0.5	mA
		V _{IN} = −10 V, 1 mA ≤ I _O ≤ 40 mA			0.1	mA
Output Noise Voltage	Vn	T _J = 25°C, 10 Hz ≤ f ≤ 100 kHz		31	200	μVr.m.s.
Ripple Rejection	R•R	$T_J = 25^{\circ}C, -8 \text{ V} \le V_{IN} \le -18 \text{ V},$ f = 120 Hz	65	85		dB
Dropout Voltage	VDIF	T _J = 25°C		0.9		V
Short Circuit Current	Oshort	T _J = 25°C, V _{IN} = -20 V		95		mA
Peak Output Current	lOpeak	T _J = 25°C	140	190	230	mA
Temperature Coefficient of Output Voltage	ΔVο/ΔT	Io = 5 mA		0.4		mV/°C

 μ PC79L08 (V_{IN} = -14 V, Io = 40 mA, 0°C \leq T_J \leq +125°C, C_{IN} = 2.2 μ F, C_{OUT} = 1 μ F, unless otherwise specified)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output Voltage	Vo	T _J = 25°C	-7.7	-8.0	-8.3	V
		$-10.5 \text{ V} \le V_{IN} \le -23 \text{ V}, 1 \text{ mA} \le I_0 \le 40 \text{ mA}$	-7.6		-8.4	V
Line Regulation	REGIN	$T_J = 25^{\circ}C, -10.5 \text{ V} \le V_{IN} \le -23 \text{ V}$		5	60	mV
Load Regulation	REG∟	T _J = 25°C, 1 mA ≤ I _O ≤ 100 mA		12	80	mV
Quiescent Current	IBIAS	T _J = 25°C		4.3	6.0	mA
Quiescent Current Change	⊿IBIAS	$-10.5 \text{ V} \le V_{\text{IN}} \le -23 \text{ V}, \text{ Io} = 40 \text{ mA}$			0.5	mA
		V _{IN} = −14 V, 1 mA ≤ lo ≤ 40 mA			0.1	mA
Output Noise Voltage	Vn	T _J = 25°C, 10 Hz ≤ f ≤ 100 kHz		56	220	μVr.m.s.
Ripple Rejection	R•R	$T_J = 25^{\circ}C$, $-12 \text{ V} \le V_{IN} \le -22 \text{ V}$, $f = 120 \text{ Hz}$	63	75		dB
Dropout Voltage	V _{DIF}	T _J = 25°C		0.9		V
Short Circuit Current	lOshort	T _J = 25°C, V _{IN} = -23 V		75		mA
Peak Output Current	lOpeak	T _J = 25°C	140	190	230	mA
Temperature Coefficient of Output Voltage	⊿Vo/⊿T	Io = 5 mA		0.6		mV/°C

 μ PC79L12 (V_{IN} = -19 V, lo = 40 mA, 0°C \leq T_J \leq +125°C, C_{IN} = 2.2 μ F, C_{OUT} = 1 μ F, unless otherwise specified)

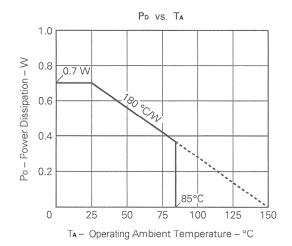
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Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output Voltage	Vo	T _J = 25°C	-11.5	-12.0	-12.5	V
		$-14.5 \text{ V} \le \text{V}_{\text{IN}} \le -27 \text{ V}, 1 \text{ mA} \le \text{Io} \le 40 \text{ mA}$	-11.4		-12.6	V
Line Regulation	REGIN	T _J = 25°C, −14.5 V ≤ V _{IN} ≤ −27 V		8	45	mV
Load Regulation	REG∟	T _J = 25°C, 1 mA ≤ I _O ≤ 100 mA		15	100	mV
Quiescent Current	IBIAS	T _J = 25°C		4.4	6.0	mA
Quiescent Current Change	⊿IBIAS	$-14.5 \text{ V} \le V_{IN} \le -30 \text{ V}, \text{ Io} = 40 \text{ mA}$			0.5	mA
		V _{IN} = −19 V, 1 mA ≤ I _O ≤ 40 mA			0.1	mA
Output Noise Voltage	Vn	$T_J = 25^{\circ}C$, 10 Hz $\leq f \leq$ 100 kHz		88	280	μVr.m.s.
Ripple Rejection	R•R	$T_J = 25^{\circ}C$, $-15 \text{ V} \le V_{IN} \le -25 \text{ V}$, $f = 120 \text{ Hz}$	55	70		dB
Dropout Voltage	VDIF	T _J = 25°C		0.9		V
Short Circuit Current	lOshort	T _J = 25°C, V _{IN} = -27 V		50		mA
Peak Output Current	lOpeak	T _J = 25°C	140	190	230	mA
Temperature Coefficient of Output Voltage	ΔVο/ΔΤ	Io = 5 mA		0.8		mV/°C

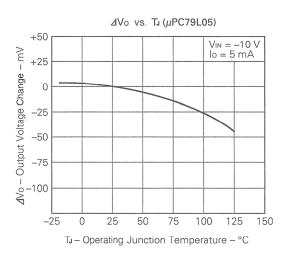
 μ PC79L15 (V_{IN} = -23 V, lo = 40 mA, 0°C \leq T_J \leq +125°C, C_{IN} = 2.2 μ F, C_{OUT} = 1 μ F, unless otherwise specified)

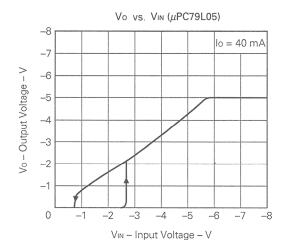
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output Voltage	Vo	T _J = 25°C	-14.4	-15.0	-15.6	V
		$-17.5 \text{ V} \le V_{IN} \le -30 \text{ V}, 1 \text{ mA} \le I_0 \le 40 \text{ mA}$	-14.25		-15.75	V
Line Regulation	REGIN	$T_J = 25^{\circ}C, -17.5 \text{ V} \le V_{IN} \le -30 \text{ V}$		10	45	mV
Load Regulation	REG∟	T _J = 25°C, 1 mA ≤ Io ≤ 100 mA		20	125	mV
Quiescent Current	IBIAS	T _J = 25°C		4.5	6.0	mA
Quiescent Current Change	⊿IBIAS	$-17.5 \text{ V} \le V_{IN} \le -30 \text{ V}, \text{ Io} = 40 \text{ mA}$			0.5	mA
		V_{IN} = -23 V, 1 mA \leq Io \leq 40 mA			0.1	mA
Output Noise Voltage	Vn	T _J = 25°C, 10 Hz ≤ f ≤ 100 kHz		100	360	μ Vr.m.s.
Ripple Rejection	R•R	$T_J = 25^{\circ}C$, $-18.5 \text{ V} \le V_{IN} \le -28.5 \text{ V}$, $f = 120 \text{ Hz}$	55	65		dB
Dropout Voltage	VDIF	T _J = 25°C		0.9		V
Short Circuit Current	lOshort	T _J = 25°C, V _{IN} = -30 V		25		mA
Peak Output Current	lOpeak	T _J = 25°C	140	190	230	mA
Temperature Coefficient of Output Voltage	ΔVο/ΔΤ	lo = 5 mA		1.0		mV/°C

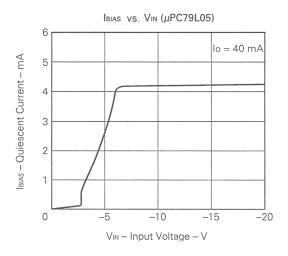
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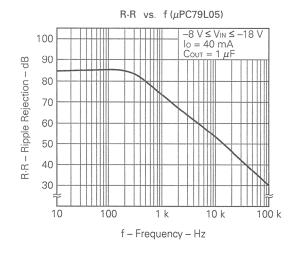
TYPICAL CHARACTERISTICS (T_J = 25°C, unless otherwise specified)

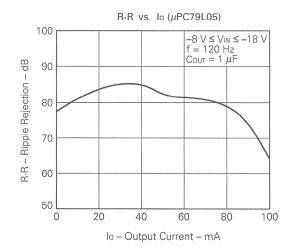


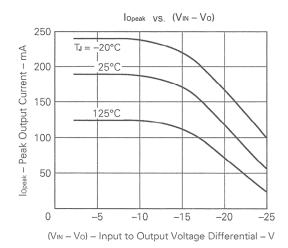


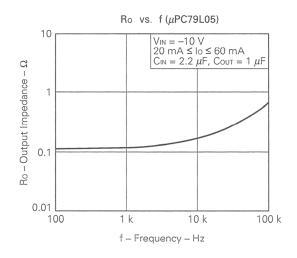


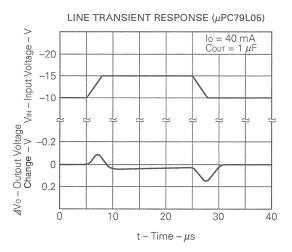


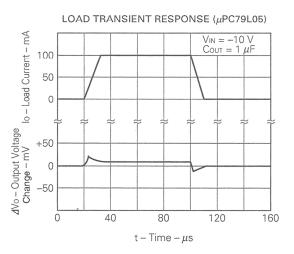






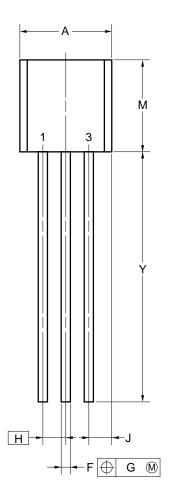


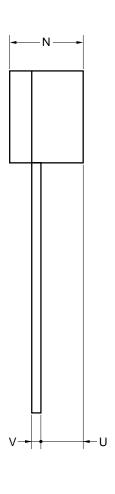




<R> PACKAGE DRAWING (Unit: mm)

3-PIN PLASTIC SIP (TO-92)





NOTE

Each lead centerline is located within 0.12 mm of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS
Α	5.0±0.2
F	$0.50^{+0.30}_{-0.10}$
G	0.12
Н	1.27
J	1.33 MAX.
М	5.0±0.5
N	4.0±0.2
U	2.8 MAX.
V	0.50±0.10
Υ	15.0±0.7

P3J-127B-3

<R> RECOMMENDED SOLDERING CONDITIONS

The μ PC79Lxx Series should be soldered and mounted under the following recommended conditions.

For soldering methods and conditions other than those recommended below, contact an NEC Electronics sales representative.

For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

Through-hole devices

μ PC79L05J, 79L08J, 79L12J, 79L15J,

μ PC79L05J-A, 79L08J-A, 79L12J-A, 79L15J-A : 3-PIN PLASTIC SIP (TO-92)

Process	Conditions	Symbol
Wave soldering	Solder temperature: 260°C or below, Flow time: 10 seconds or less,	WS60-00-1
(only to leads)	Maximum number of flow processes: 1 time.	
Partial heating method	Pin temperature: 350°C or below,	P350
	Heat time: 3 seconds or less (Per each pin).	

Caution For through-hole device, the wave soldering process must be applied only to leads, and make sure that the package body does not get jet soldered.

<R> REFERENCE DOCUMENTS

Document Name	Document No.		
Usage of Three-Terminal Regulators User's Manual	G12702E		
Semiconductor Device Mount Manual	http://www.necel.com/pkg/en/mount/index.html		
Review of Quality and Reliability Handbook Information	C12769E		

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